Features

Miniaturized packaging size suitable for high-density applications:
nom 0.039″ x 0.024″ (1.0x0.6mm)
Standard Capacitance 20 pF
Low Clamping Voltage:V_C=16V@I_{PP}=6.5A
Reverse Working (Stand-off) Voltage: 7.0V
Low Leakage current
Response Time is Typically < 1 ns

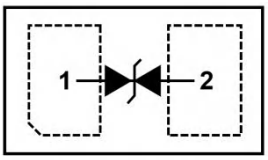


Applications

Smartphones, tablet computers
Blu-ray and DVD recorders and players
Video equipment and accessories



DFN1006-2L(Pb-Free)



Schematic Diagram

Absolute Maximum Rating

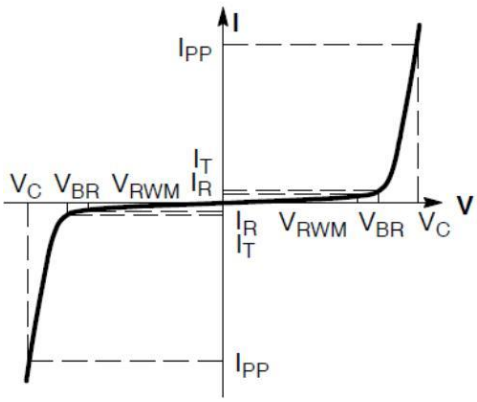
Rating	Symbol	Value	Unit
Peak pulse power (tp = 8/20μs)	P_{PK}	105	W
ESD according to IEC61000-4-2 air discharge	V_{ESD}	±30	kV
ESD according to IEC61000-4-2 contact discharge		±30	
Operating Temperature Range	T_J	-55~150	℃
Storage temperature	T_{STG}	-55~150	℃

Electrical Characteristics (TA=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Reverse Stand-off Voltage	V_{RWM}				7.0	V
Reverse Breakdown Voltage	V_{BR}	I_T=1mA	7.6		9.0	V
Reverse Leakage Current	I_R	V_{RWM}=±7.0V			100	nA
Clamping Voltage	V_C	I_{PP}=1.0A ,tp=8/20us		9	12	V
Clamping Voltage	V_C	I_{PP}=6.5A ,tp=8/20us		10	16	V
Junction Capacitance	C_J	V_R=0V, f =1MHz		15	20	pF

Electrical Parameters (TA = 25°C unless otherwise noted)

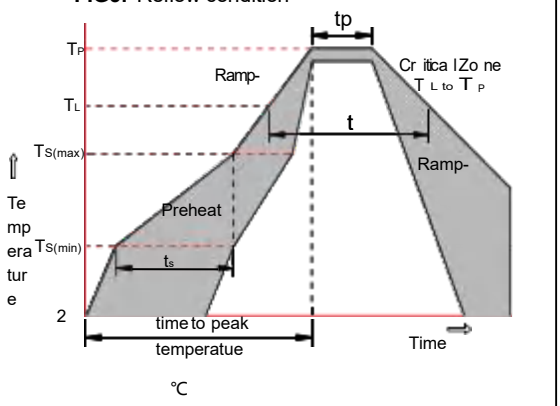
Symbol	Parameter
I_{PP}	Maximum Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Maximum Reverse Leakage Current @ V_{RWM}
I_T	Test Current
V_{BR}	Breakdown Voltage @ I_T
P_{PK}	Peak Power Dissipation
C	Max. Capacitance @ V_R = 0 and freq.=1 MHz



Soldering parameters

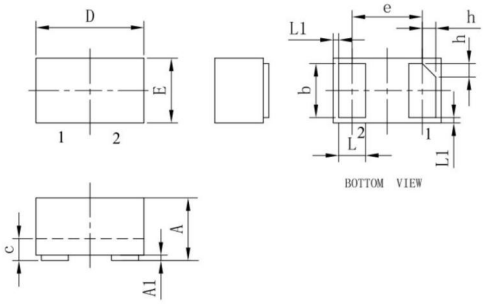
Reflow Condition		Pb-Free assembly (see as bellow)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150℃
	-Temperature Max($T_{s(max)}$)	+200℃
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3℃/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217℃
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)℃
Time within 5℃ of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T_P)		8 min. Max
Do not exceed		+260℃

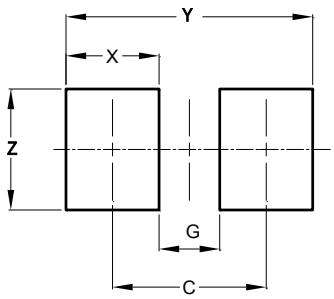
FIG5: Reflow condition



Package Dimensions & Suggested Pad Layout

DFN1006-2L





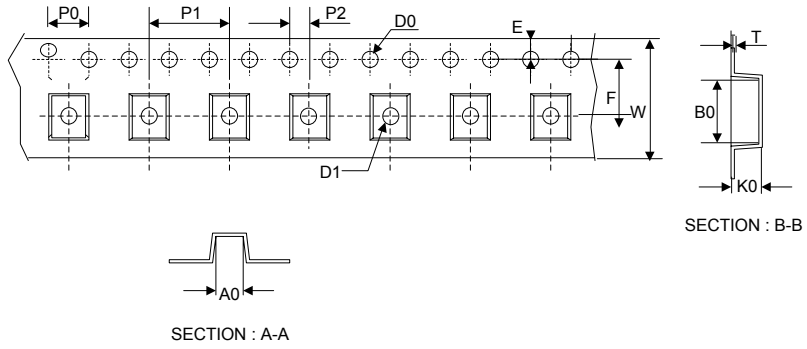
DFN1006-2L

	Millimeters			Inches		
	Min. (mm)	Typ. (mm)	Max. (mm)	Min. (mm)	Typ. (mm)	Max. (mm)
A	0.45	0.50	0.55	0.018	0.020	0.022
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.45	0.50	0.55	0.018	0.020	0.022
c	0.12	0.15	0.18	0.005	0.006	0.007
D	0.95	1.00	1.05	0.037	0.039	0.041
e	0.59BSC			0.026BSC		
E	0.55	0.60	0.65	0.022	0.024	0.026
L	0.25	0.30	0.35	0.010	0.012	0.013
L1	0.05REF			0.002REF		
h	0.07	0.12	0.17	0.003	0.005	0.007

Dimensions	Value (in mm)
C	0.70
G	0.30
X	0.40
Y	1.10
Z	0.65

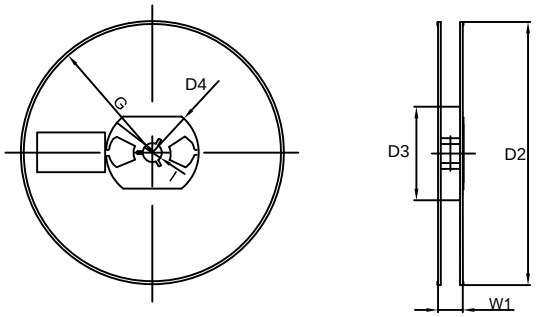
Tape & rell specification

Tape



Symbol	Dimension (mm)
P0	4.00±0.20
P1	2.00±0.20
P2	1.55±0.20
D0	1.55±0.20
D1	0.40±0.20
E	1.55±0.25
F	3.60±0.20
W	8.00±0.20
A0	1.00±0.20
B0	1.40±0.20
K0	0.75±0.20
T	0.20±0.20

7” Reel



D2	177.0±5.0
D3	55Min.
D4	R24.6±2.0
G	R82.0±2.0
I	13.0±2.0
W1	10.20±3.0
Quantity: 3000PCS	